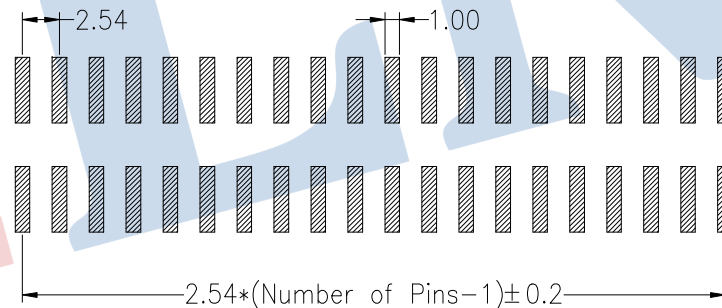
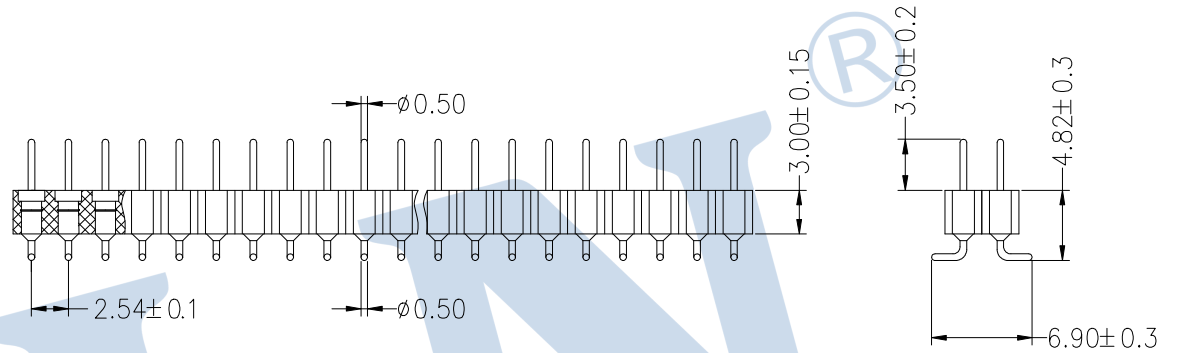
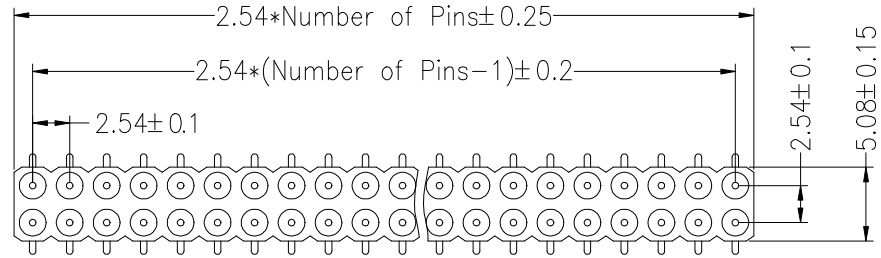


HSF RoHS

SPECIFICATIONS

Current Rating:3.0AMP
 Contact Resistance:10mΩ Max
 Dielectric Strength:Min 1000V RMS
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au Over Ni
 Insulator Material:Polyester(UL94V-0)
 Resistance To Soldering Heat:
 260° C±5° C, 10s(PPS insulator)



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

Ordering Information

3610 30 2 XX M XX 100 X X

No.of Pins
Per Row
2-40

Contact Plating
SN:Tin
G1:Gold Flash
G2:2U" Gold
G3:3U" Gold
G4:5U" Gold
G5:10U" Gold

Length
100=10.0mm

Packing
0=PE Bag
A=Tray
T=Tube

				OPERATION		DRAW	BEN	14.04.01	SCALE	FIT	JILN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONICS CO.,LTD Tel: 86-755-27483253 Fax: 86-755-2997-5588	
				X.X	±0.30				UNIT	mm		
				X.XX	±0.20	CHECK	SIZE	A4				
				X.XXX	±0.10	APPROVE	SHEET	1/1				
A0	2014.04.01	NEW DRAWING		Angle	±3°			PROJ.		PART NO.	3610302XXMXX100XX	
REV	DATE	MODIFICATION DESCRIPTION		DIM	TOL					TITLE:	2.54X3.0 双头针 SMT L=10.0	